## Product Specification

## PE42451

## Product Description

The PE42451 is a HaRPTM-enhanced sbsorptive SP5T RF wwitch developed on the UltraCMOS ${ }^{\circledR}$ process technology. This general purpose switch is comprised of five symmetric RF ports and has very high isolation. An on-chip CMOS decode logic facilitates a three-pin low voltage CMOS control interface and an optional external Vss feature (Vss ${ }_{\text {Ext }}$ ). High ESD tolerance and no blocking capacitor requirements make this the ultimate in integration and ruggedness.
pSemi's HaRP ${ }^{\text {TM }}$ technology enhancements deliver high linearity and exceptional harmonics performance. It is an innovative feature of the UltraCMOS ${ }^{\circledR}$ process, providing performance superior to GaAs with the economy and integration of conventional CMOS.

Figure 1. Functional Diagram


## SP5T Absorptive UltraCMOS ${ }^{\circledR}$

High-Isolation RF Switch 450-5000 MHz, Vss Ext option

## Features

- HaRP ${ }^{\text {tm }}$-enhanced UltraCMOS ${ }^{\circledR}$ device
- Five symmetric, absorptive RF ports
- High Isolation:
- 68 dB at 450 MHz
- 62 dB at 900 MHz
- 55 dB at 2100 MHz
- 53 dB at 2600 MHz
- 50 dB at 4000 MHz
- 43 dB at 5000 MHz
- IIP2 of 95 dBm , IIP3 of 58 dBm
- High ESD tolerance of 3500 V HBM
- Optional External Vss Control (Vss ExT )
- Three pin CMOS logic control
- No blocking capacitors required
- Small RoHS-Compliant 24-lead 4x4 mm QFN package

Figure 2. Package Photo
24-lead $4 \times 4$ mm QFN


Table 1. Electrical Specifications @ $25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=3.0 \mathrm{~V}\left(\mathrm{Z}_{\mathrm{S}}=\mathrm{Z}_{\mathrm{L}}=50 \Omega\right)$

| Electrical Parameter | Path | Condition | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Operating Frequency |  |  | 450 |  | 5000 | MHz |
| Insertion Loss, IL | RFC - RFX <br> RFC - RFX <br> RFC - RFX <br> RFC - RFX <br> RFC - RFX <br> RFC - RFX | $\begin{gathered} 450 \mathrm{MHz} \\ 900 \mathrm{MHz} \\ 2100 \mathrm{MHz} \\ 2600 \mathrm{MHz} \\ 4000 \mathrm{MHz} \\ 5000 \mathrm{MHz} \end{gathered}$ |  | $\begin{aligned} & 1.60 \\ & 1.65 \\ & 1.95 \\ & 2.05 \\ & 2.25 \\ & 2.50 \end{aligned}$ | $\begin{aligned} & 1.95 \\ & 2.05 \\ & 2.30 \\ & 2.40 \\ & 2.75 \\ & 3.15 \end{aligned}$ | dB <br> dB <br> dB <br> dB <br> dB <br> dB |
| Isolation, Iso | RFC/RFX - RFX RFC/RFX - RFX RFC/RFX - RFX RFC/RFX - RFX RFC/RFX - RFX RFC/RFX - RFX | $\begin{gathered} 450 \mathrm{MHz} \\ 900 \mathrm{MHz} \\ 2100 \mathrm{MHz} \\ 2600 \mathrm{MHz} \\ 4000 \mathrm{MHz} \\ 5000 \mathrm{MHz} \end{gathered}$ | $\begin{aligned} & 58.5 \\ & 53.0 \\ & 46.5 \\ & 46.5 \\ & 45.0 \\ & 41.0 \end{aligned}$ | $\begin{aligned} & 68 \\ & 62 \\ & 55 \\ & 53 \\ & 50 \\ & 43 \end{aligned}$ |  | dB <br> dB <br> dB <br> dB <br> dB <br> dB |
| Return Loss, Active Port | RFX - RFX | $\begin{gathered} 450-4000 \mathrm{MHz} \\ 4000-5000 \mathrm{MHz} \end{gathered}$ |  | $\begin{aligned} & 16 \\ & 14 \end{aligned}$ |  | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{~dB} \end{aligned}$ |
| Return Loss, Terminated Port | RFX - RFX | $\begin{gathered} 450-4000 \mathrm{MHz} \\ 4000-5000 \mathrm{MHz} \end{gathered}$ |  | $\begin{aligned} & 15 \\ & 12 \end{aligned}$ |  | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{~dB} \end{aligned}$ |
| Input 1 dB compression ${ }^{1}$, P1dB | RFX - RFC | 450-5000 MHz, 100\% duty cycle |  | 35 |  | dBm |
| Input IP2 | RFX - RFC | 450-5000 MHz, 100\% duty cycle |  | 95 |  | dBm |
| Input IP3 | RFX - RFC | 450-5000 MHz, 100\% duty cycle |  | 58 |  | dBm |
| Switching Time, $\mathrm{T}_{\text {sw }}$ | $\begin{aligned} & \text { "On" } \\ & \text { "Off" } \end{aligned}$ | 50\% Control to 90\% RF 50\% Control to 10\% RF |  | $\begin{aligned} & 200 \\ & 200 \\ & \hline \end{aligned}$ | $\begin{aligned} & 500 \\ & 500 \\ & \hline \end{aligned}$ | $\begin{aligned} & \mathrm{ns} \\ & \mathrm{~ns} \end{aligned}$ |

Notes: 1. Please refer to Maximum Operating Power in Table 2

Table 2. Operating Ranges

| Parameter | Symbol | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {DD }}$ Supply Voltage | $V_{D D}$ | 2.7 | 3.0 | 3.3 | V |
| $\mathrm{VSS}_{\text {Ext }}$ Negative Power Supply Voltage ${ }^{2}$ | Vss ${ }_{\text {Ext }}$ | -3.3 | -3.0 | -2.7 | V |
| Iod Power Supply Current $\mathrm{V}_{\mathrm{DD}}=3.0 \mathrm{~V}, \mathrm{P}_{\mathrm{IN}}=0 \mathrm{dBm}$ | $\mathrm{I}_{\mathrm{DD}}$ |  | 14 |  | $\mu \mathrm{A}$ |
| IDD Max Power Supply Current $\mathrm{V}_{\mathrm{DD}}=3.3 \mathrm{~V}, \mathrm{P}_{\mathrm{MAX}}=33 \mathrm{dBm}$, Temperature $=-40^{\circ} \mathrm{C}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{DD}} \\ & (\max ) \end{aligned}$ |  |  | 50 | $\mu \mathrm{A}$ |
| Control Voltage High | $\mathrm{V}_{\mathrm{H}}$ | $\begin{array}{\|c\|c} 0.7 x \\ V_{D D} \end{array}$ |  | $V_{\text {DD }}$ | V |
| Control Voltage Low | VIL | 0 |  | $\begin{aligned} & 0.3 x \\ & V_{D D} \end{aligned}$ | V |
| $\mathrm{I}_{\text {CTRL }}$ Control Current ${ }^{3}$ | $\mathrm{I}_{\text {ctre }}$ |  |  | 1 | $\mu \mathrm{A}$ |
| Maximum Operating Power (RFX-RFC, All Bands (50 ), 100\% duty cycle) | $\mathrm{P}_{\text {max }}$ |  |  | 33 | dBm |
| Maximum power into termination (RFX, All Bands (50』),100\% duty cycle) | $\mathrm{P}_{\text {max }}$ |  |  | 24 | dBm |
| Operating temperature range | Top | -40 |  | +105 | ${ }^{\circ} \mathrm{C}$ |

[^0]Figure 3. Pin Configuration (Top View)


Table 3. Pin Descriptions

| Pin \# | Name | Description |
| :---: | :---: | :---: |
| $\begin{gathered} 1,3,4,6,7,9,10, \\ 12,13,15,21,23,24 \end{gathered}$ | GND | Ground |
| 2 | RF54 | RF I/O |
| 5 | RF4 ${ }^{4}$ | RF I/O |
| 8 | RF3 ${ }^{4}$ | RF I/O |
| 11 | RF2 ${ }^{4}$ | RF I/O |
| 14 | RF14 | RF I/O |
| 16 | $V_{\text {D }}$ | Supply |
| 17 | V1 | Switch control input, CMOS logic level |
| 18 | V2 | Switch control input, CMOS logic level |
| 19 | V3 | Switch control input, CMOS logic level |
| 20 | $\begin{aligned} & \mathrm{VSS}_{\mathrm{ExT}} / \\ & \mathrm{GND}^{5} \\ & \hline \end{aligned}$ | External Vss Control / Ground |
| 22 | RFC ${ }^{4}$ | RF Common |
| Paddle | GND | Ground for proper device operation |

Note: 4. Blocking capacitors needed only when non-zero DC voltage present.
5. Pin 20 must be grounded when using internal Vss supply

Table 4. Absolute Maximum Ratings

| Symbol | Parameter/Conditions | Min | Max | Units |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{T}_{\text {st }}$ | Storage temperature range | -60 | +150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{P}_{\text {max }}$ | Maximum Operating Power (RFX-RFC, All Bands (50 ), 100\% duty cycle) |  | 33 | dBm |
| $\mathrm{P}_{\text {max }}$ | Maximum power into termination (RFX, All Bands (50ת), $100 \%$ duty cycle) |  | 24 | dBm |
| $\mathrm{V}_{\text {ESD }}$ | ESD Voltage $\mathrm{HBM}^{6}$, All Pins |  | 3500 | V |
| $V_{\text {ESD }}$ | ESD Voltage MM ${ }^{7}$, All Pins |  | 150 | V |
| Notes: | 6. Human Body Model ESD Voltage (HBM, MIL_STD 883 Method 3015.7) <br> 7. Machine Model ESD Voltage (JESD22-A115-A) |  |  |  |

Exceeding absolute maximum ratings may cause permanent damage. Operation should be restricted to the limits in the Operating Ranges table.

## Electrostatic Discharge (ESD) Precautions

When handling this UltraCMOS ${ }^{\circledR}$ device, observe the same precautions that you would use with other ESDsensitive devices. Although this device contains circuitry to protect it from damage due to ESD, precautions should be taken to avoid exceeding the specified rating.

## Latch-Up Avoidance

Unlike conventional CMOS devices, UltraCMOS ${ }^{\circledR}$ devices are immune to latch-up.

## Moisture Sensitivity Level

The Moisture Sensitivity Level rating for the PE42451 in the 24 -lead $4 \times 4$ QFN package is MSL1.

## Optional External Vss Control (Vssext)

For proper operation, the Vssext control must be grounded or at the Vss voltage specified in the Operating Ranges table (Table 2). When the Vssext control pin on the package is grounded the switch FET's are biased with an internal low spur negative voltage generator. For applications that require the lowest possible spur performance, Vssext can be applied to bypass the internal negative voltage generator to eliminate the spurs.

## Switching Frequency

The PE42451 has a maximum 25 kHz switching rate when the internal negative voltage generator is used (pin 20=GND). The rate at which the PE42451 can be switched is only limited to the switching time if an external -3 V supply is provided (pin $20=\mathrm{Vss}_{\mathrm{ExT}}$ ).

Table 5. Truth Table

| Mode | V3 | V2 | V1 |
| :--- | :---: | :---: | :---: |
| All off | 0 | 0 | 0 |
| RF1 on | 0 | 0 | 1 |
| RF2 on | 0 | 1 | 0 |
| RF3 on | 0 | 1 | 1 |
| RF4 on | 1 | 0 | 0 |
| RF5 on | 1 | 0 | 1 |
| All off | 1 | 1 | 0 |
| Unsupported | 1 | 1 | 1 |

## Evaluation Kit

The SP5T switch EK Board was designed to ease customer evaluation of pSemi's PE42451. The RF common port is connected through a $50 \Omega$ transmission line via the top SMA connector. RF1, RF2, RF3 and RF4 are connected through $50 \Omega$ transmission lines via side SMA connectors. A through $50 \Omega$ transmission is available via SMA connectors RFCAL1 and RFCAL2. This transmission line can be used to estimate the loss of the PCB over the environmental conditions being evaluated.

The EVK board is constructed with four metal layers on dielectric materials of Rogers 4003C and 4450 with a total thickness of 32 mils. Layer 1 and layer 3 provide ground for the 50 ohm transmission lines. The 50 ohm transmission lines are designed in layer 2 for high isolation purpose and use a stripline waveguide design with a trace width of 9.4 mils and trace metal thickness of 1.8 mils. The board stack up for 50 ohm transmission lines has 8 mil thickness of Rogers 4003C between layer 1 and layer 2, and 10 mil thickness of Rogers 4450 between layer 2 and layer 3 . Please consult manufacturer's guidelines for proper board material properties in your application. The PCB should be designed in such a way that RF transmission lines and sensitive DC i/o traces such as $\mathrm{VSS}_{\text {EXT }}$ are heavily isolated from one another, otherwise the true performance of the PE42451 will not be yielded.

Figure 4. Evaluation Board Layouts
pSemi Specification PRT-50444


Figure 5. Evaluation Board Schematic
pSemi Specification DOC-44837


Product Specification

## Performance Plots @ $25^{\circ} \mathrm{C}$ and 3.0 V unless otherwise specified.

Figure 6. Insertion Loss vs. Frequency Over Voltages


Figure 7. Insertion Loss vs. Frequency Over Temperatures


Figure 8. Insertion Loss vs. Frequency, All Paths


## Performance Plots @ $25^{\circ} \mathrm{C}$ and 3.0 V unless otherwise specified

Figure 9. Isolation: RFC-RFX @ 3.0 V


Figure 11. Isolation: RFX-RFX @ 3.0 V


Figure 10. Isolation: RFC-RFX @ $25^{\circ} \mathrm{C}$


Figure 12. Isolation: RFX-RFX @ $25^{\circ} \mathrm{C}$


## Performance Plots @ $25^{\circ} \mathrm{C}$ and 3.0 V unless otherwise specified (Continued)

Figure 13. Return Loss at Active Port @ 3.0 V


Figure 15. Return Loss: RFC @ 3.0 V


Figure 17. Return Loss: All Paths, Terminated


## Performance Plots @ $25^{\circ} \mathrm{C}$ and 3.0 V unless otherwise specified (Continued)

Figure 18. Nominal Linearity Performance (IIP3)


Figure 19. Nominal Linearity Performance (IIP2)


Figure 20. Package Drawing
24-lead 4x4 mm QFN


Figure 21. Tape and Reel Drawing


## SECIIN A - A



Figure 22. Marking Specifications


YYWW = Date Code
ZZZZZ = Last five digits of Lot Number

DOC-51207

Product Specification

Table 6. Ordering Information

| Order Code | Part Marking | Description | Package | Shipping Method |
| :---: | :---: | :---: | :---: | :---: |
| PE42451MLIAA | 42451 | PE42451G-24QFN 4x4mm-cut off tape and reel | Green 24-lead 4x4mm QFN | Bulk or tape cut from reel |
| PE42451MLIAA-Z | 42451 | PE42451G-24QFN 4x4mm-3000C | Green 24-lead 4x4mm QFN | 3000 units / T\&R |
| EK42451-01 | PE42451-EK | PE42451-24QFN 4x4mm-EK | Evaluation Kit | $1 /$ Box |

## Sales Contact and Information

## For sales and contact information please visit www.psemi.com.

Advance Information: The product is in a formative or design stage. The datasheet contains design target specifications for product development. Specifications and features may change in any manner without notice. Preliminary Specification: The datasheet contains preliminary data. Additional data may be added at a later date. pSemi reserves the right to change specifications at any time without notice in order to supply the best possible product. Product Specification: The datasheet contains final data. In the event pSemi decides to change the specifications, pSemi will notify customers of the intended changes by issuing a CNF (Customer Notification Form).
The information in this document is believed to be reliable. However, pSemi assumes no liability for the use of this information. Use shall be entirely at the user's own risk.

No patent rights or licenses to any circuits described in this document are implied or granted to any third party pSemi 's products are not designed or intended for use in devices or systems intended for surgical implant, or in other applications intended to support or sustain life, or in any application in which the failure of the pSemi product could create a situation in which personal injury or death might occur. pSemi assumes no liability for damages, including consequential or incidental damages, arising out of the use of its products in such applications.
The Peregrine Semiconductor name, Peregrine Semiconductor logo and UItraCMOS are registered trademarks and the pSemi name, pSemi logo, HaRP and DuNE are trademarks of pSemi Corporation in the U.S. and other countries.
pSemi products are protected under one or more of the following U.S. patents: patents.psemi.com.

## X-ON Electronics

Largest Supplier of Electrical and Electronic Components
Click to view similar products for RF Switch ICs category:
Click to view products by pSemi manufacturer:
Other Similar products are found below :
MASW-008853-TR3000 BGS13SN8E6327XTSA1 BGSX210MA18E6327XTSA1 SKY13446-374LF SW-227-PIN CG2185X2 CG2415M6 MA4SW410 MA4SW410B-1 MASW-002102-13580G MASW-008543-001SMB MASW-008955-TR3000 TGS4307 BGS 12PL6 E6327 BGS1414MN20E6327XTSA1 BGS1515MN20E6327XTSA1 BGSA11GN10E6327XTSA1 BGSX28MA18E6327XTSA1 HMC199AMS8 HMC986A SKY13374-397LF SKY13453-385LF CG2430X1-C2 CG2415M6-C2 HMC986A-SX SW-314-PIN UPG2162T5N-E2-A SKY13416-485LF MASWSS0204TR-3000 MASWSS0201TR MASWSS0181TR-3000 MASW-007588-TR3000 MASW-004103-13655P MASW-003102-13590G MASWSS0202TR-3000 MA4SW310B-1 MA4SW110 SW-313-PIN CG2430X1 SKY13321-360LF SKY13405490LF BGSF 18DM20 E6327 MMS008PP3 BGS13PN10E6327XTSA1 SKY13319-374LF BGS14PN10E6327XTSA1 SKY12213-478LF SKY13404-466LF MASW-011060-TR0500 SKYA21024


[^0]:    Note: 2. Applied only when external Vss power supply used. Pin 20 must be grounded when using internal Vss supply. 3. Pull-down resistor in EVK schematic may increase control current.

